

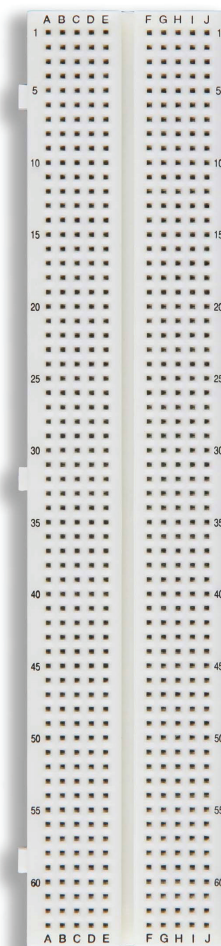
GS-630

630 TIE-POINT, SOLDERLESS BREADBOARD

Applications

The GS-630 is a modular type solderless breadboard that connects with the GS-100 bus strip to make a 830 tie point breadboard (GS-830). Expandable, it is a great way to prototype low frequency or DC powered circuits. It is ideal for:

- Educational labs
- Hobbyists



Features

- 630 Tie-points
- ABS plastic body
- Square hole style
- Interlocking tabs
- Peel and stick adhesive
- Nickel plated phosphor bronze spring clip contacts
- Allowable wire diameter of 0.4-0.7 mm
- Fits 7 total 16-pin ICs
- Measures 6.5 x 1.375 x 0.33 in
- Maximum capacity of 1.5 A at 36 V
- RoHS compliant
- Three-year warranty

GS-630

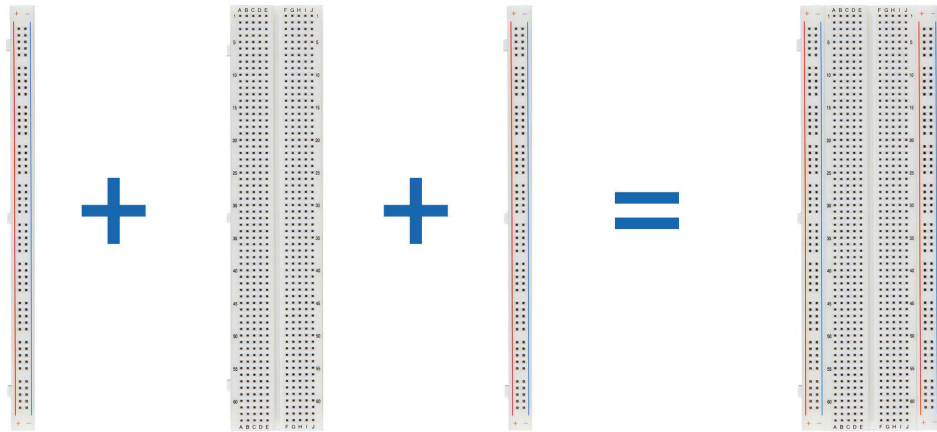
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GS-830 Components



GS-100*

GS-630

GS-100*

GS-830

*The GS-100 is sold as a pack of two